

In re

Patent Application of

Sachiko NISHIURA

Application No. 09/454,755

Filed: December 6, 1999

APPARATUS AND METHOD FOR CONVERTING AN OBJECT DISPLAY DESCRIPTION DOCUMENT

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT PURSUANT TO 37 CFR §1.97(c)

Commissioner for Patents Washington, D.C. 20231

Sir:

The Examiner's attention is directed to the references which are listed on the attached Form PTO/SB/08A and/or PTO/SB/08B and copies of which are attached. Citation of these references is respectfully requested.

Each item of information contained in this information disclosure statement was cited in a communication from a foreign patent office in a counterpart foreign application. A copy of the Japanese Office Action is enclosed, and its relevant portion is identified by wavy lines for which a translation is attached. The Office Action did not yield any reasons for refusal. No concession is made that these documents are prior art, and Applicant expressly reserves the right to antedate the documents as may be appropriate. A copy of each reference listed is attached.

AUTHORIZATION TO PAY AND PETITION FOR THE ACCEPTANCE OF ANY NECESSARY FEES: If any charges or fees must be paid in connection with the following Communication (including but not limited to the payment of issue fees), they may be paid out of our deposit account No. 50-1965. If this payment also requires a Petition, please construe this authorization to pay as the necessary Petition which is required to accompany the payment.

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Examiner: Ryan R. YANG

Confirmation No.: 4202

Attorney Docket No.: 204432-0019

Date: February 7, 2003

Respectfully submitted,

Martin L. Stern, Reg. No. 28,911 Michael Best & Friedrich LLC 401 North Michigan Avenue

Suite 1900

Chicago, Illinois 60611

Telephone: (312) 222-0800 Facsimile: (312) 222-0818

## **CERTIFICATE OF MAILING**

I, Vanessa Quail, hereby certify that this correspondence is being deposited with the US Postal Service as first class mail in an envelope addressed to Commissioner for Patents, Washington, D.C. 20231, on the date of my signature.

Signature

Date of Signature: February 7, 2003